TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74HC157AP, TC74HC157AF, TC74HC157AFN
TC74HC158AP, TC74HC158AF, TC74HC158AFN

TC74HC157AP/AF/AFN QUAD 2 – CHANNEL MULTIPLEXER
TC74HC158AP/AF/AFN QUAD 2 – CHANNEL MULTIPLEXER (INVERTING)

(Note) The JEDEC SOP (FN) is not available in Japan.

The TC74HC157A and TC74HC158A are high speed CMOS 2 - CHANNEL MULTIPLEXERs fabricated with silicon gate C^2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The TC74HC158A is an inverting multiplexer while the TC74HC157A is a non-inverting.

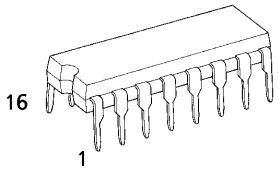
When $\overline{STROBE}$ is held high, selection of data is inhibited and all the outputs become low in the case of HC157A or high in the case of HC158A.

The SELECT decoding determines whether the A or B inputs get transferred to their corresponding Y ($\overline{Y}$) outputs.

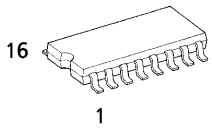
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES :

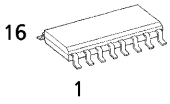
- High Speed ····· t_{pd} = 10ns(typ.) at V_{CC} = 5V
- Low Power Dissipation ····· I_{CC} = 4μA(Max.) at Ta = 25°C
- High Noise Immunity ····· $V_{NIH} = V_{NIL}$ = 28% V_{CC} (Min.)
- Output Drive Capability ····· 10 LSTTL Loads
- Symmetrical Output Impedance ··· $|I_{OH}| = I_{OL}$ = 4mA(Min.)
- Balanced Propagation Delays ····· $t_{pLH} \simeq t_{pHL}$
- Wide Operating Voltage Range ···· V_{CC} (opr.) = 2V ~ 6V
- Pin and Function Compatible with 74LS157/158



P (DIP16-P-300-2.54A)
Weight : 1.00g (Typ.)



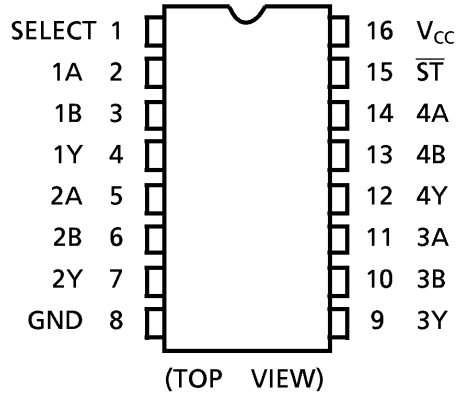
F (SOP16-P-300-1.27)
Weight : 0.18g (Typ.)



FN (SOL16-P-150-1.27)
Weight : 0.13g (Typ.)

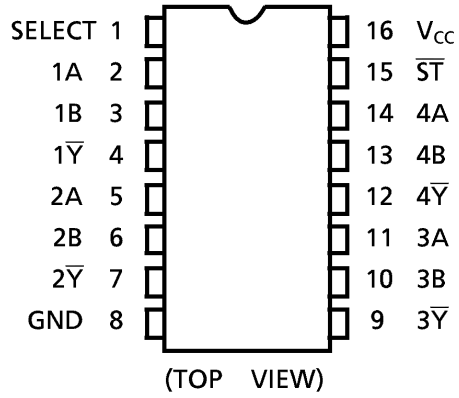
PIN ASSIGNMENT

TC74HC157A



(TOP VIEW)

TC74HC158A



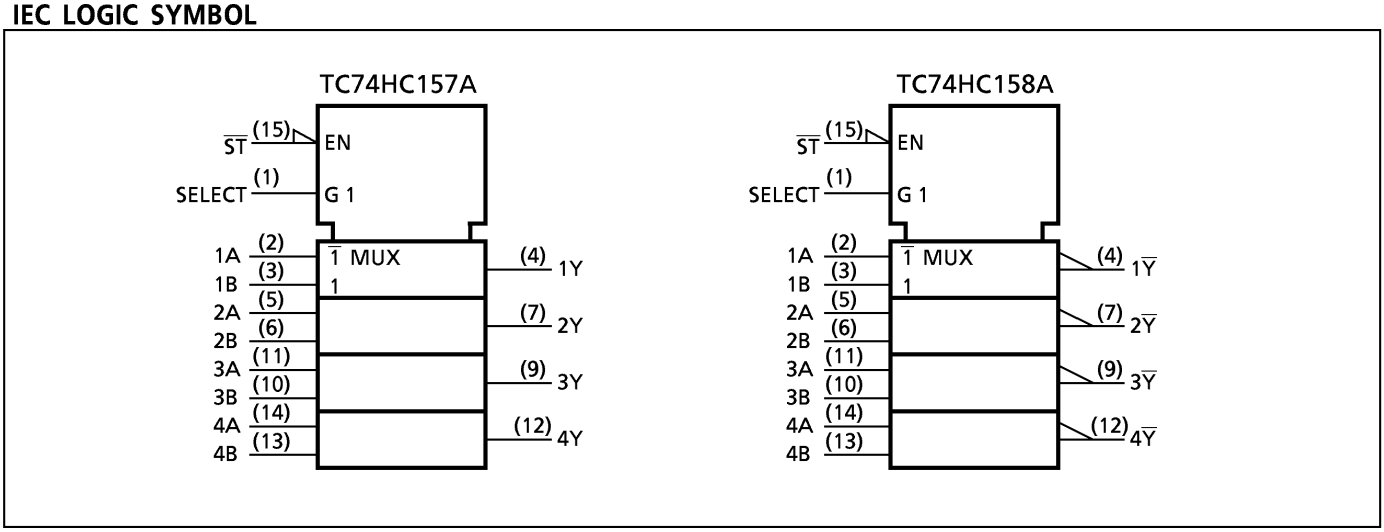
(TOP VIEW)

TRUTH TABLE

INPUTS				OUTPUTS	
$\overline{ST}$	SELECT	A	B	Y (157A)	$\overline{Y}$ (158A)
H	X	X	X	L	H
L	L	L	X	L	H
L	L	H	X	H	L
L	H	X	L	L	H
L	H	X	H	H	L

X : Don't Care

IEC LOGIC SYMBOL



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V_{CC}	−0.5~7	V
DC Input Voltage	V_{IN}	−0.5~V_{CC}+0.5	V
DC Output Voltage	V_{OUT}	−0.5~V_{CC}+0.5	V
Input Diode Current	I_{IK}	±20	mA
Output Diode Current	I_{OK}	±20	mA
DC Output Current	I_{OUT}	±25	mA
DC V_{CC} / Ground Current	I_{CC}	±50	mA
Power Dissipation	P_D	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T_{stg}	−65~150	°C

*500mW in the range of Ta= −40°C~65°C. From Ta=65°C to 85 °C a derating factor of −10mW/ °C shall be applied until 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V_{CC}	2~6	V
Input Voltage	V_{IN}	0~V_{CC}	V
Output Voltage	V_{OUT}	0~V_{CC}	V
Operating Temperature	T_{opr}	−40~85	°C
Input Rise and Fall Time	t_r, t_f	0~ 1000 (V_{CC}=2.0V) 0~ 500 (V_{CC}=4.5V) 0~ 400 (V_{CC}=6.0V)	ns

DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION		V_{CC} (V)	Ta=25°C MIN.	Ta=25°C TYP.	Ta=25°C MAX.	Ta=−40~85°C MIN.	Ta=−40~85°C MAX.	UNIT
High - Level Input Voltage	V_{IH}			2.0 4.5 6.0	1.50 3.15 4.20	− − −	− − −	1.50 3.15 4.20	− − −	V
Low - Level Input Voltage	V_{IL}			2.0 4.5 6.0	− − −	− − −	0.50 1.35 1.80	− − −	0.50 1.35 1.80	V
High - Level Output Voltage	V_{OH}	V_{IN}= V_{IH} or V_{IL}	I_{OH}=−20μA	2.0 4.5 6.0	1.9 4.4 5.9	2.0 4.5 6.0	− − −	1.9 4.4 5.9	− − −	V
			I_{OH}=−4 mA I_{OH}=−5.2mA	4.5 6.0	4.18 5.68	4.31 5.80	− −	4.13 5.63	− −	
Low - Level Output Voltage	V_{OL}	V_{IN}= V_{IH} or V_{IL}	I_{OL}=20μA	2.0 4.5 6.0	− − −	0.0 0.0 0.0	0.1 0.1 0.1	− − −	0.1 0.1 0.1	V
			I_{OL}=4 mA I_{OL}=5.2mA	4.5 6.0	− −	0.17 0.18	0.26 0.26	− −	0.33 0.33	
Input Leakage Current	I_{IN}	V_{IN}=V_{CC} or GND		6.0	−	−	±0.1	−	±1.0	μA
Quiescent Supply Current	I_{CC}	V_{IN}=V_{CC} or GND		6.0	−	−	4.0	−	40.0	

AC ELECTRICAL CHARACTERISTICS (C_L = 15pF, V_{CC} = 5V, Ta = 25°C, Input $t_r = t_f$ = 6ns)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	t_{TLH} t_{THL}		—	4	8	ns
Propagation Delay Time (A, B−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		—	10	16	
Propagation Delay Time (SELECT−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		—	13	21	
Propagation Delay Time ($\overline{STOROBE}$−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		—	10	19	

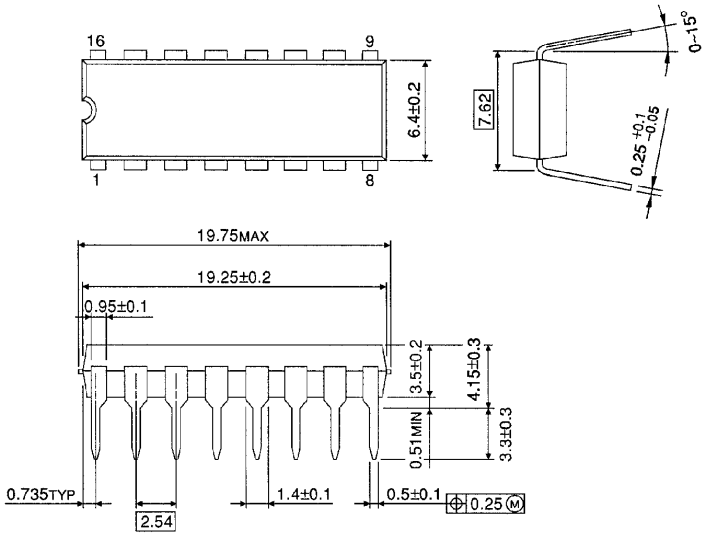
AC ELECTRICAL CHARACTERISTICS (C_L = 50pF, Input $t_r = t_f$ = 6ns)

PARAMETER	SYMBOL	TEST CONDITION	V_{CC} (V)	Ta = 25°C MIN.	Ta = 25°C TYP.	Ta = 25°C MAX.	Ta = −40~85°C MIN.	Ta = −40~85°C MAX.	UNIT
Output Transition Time	t_{TLH} t_{THL}		2.0 4.5 6.0	— — —	30 8 7	75 15 13	— — —	95 19 16	ns
Propagation Delay Time (A, B−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		2.0 4.5 6.0	— — —	36 12 10	100 20 17	— — —	125 25 21	
Propagation Delay Time (SELECT−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		2.0 4.5 6.0	— — —	50 16 14	125 25 21	— — —	155 31 26	
Propagation Delay Time ($\overline{STOROBE}$−Y, $\overline{Y}$)	t_{pLH} t_{pHL}		2.0 4.5 6.0	— — —	36 12 10	115 23 20	— — —	145 29 25	
Input Capacitance	C_{IN}			—	5	10	—	10	pF
Power Dissipation Capacitance	C_{PD} (1)	TC74HC157A		—	57	—	—	—	
		TC74HC158A		—	53	—	—	—	

Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.
Average operating current can be obtained by the equation:

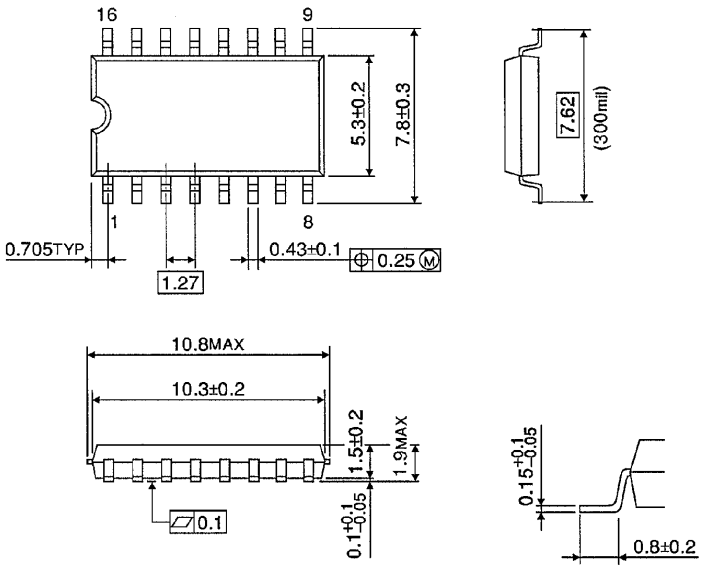
$$I_{CC}(opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4 \text{ (per bit)}$$

DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A) Unit in mm



Weight : 1.00g (Typ.)

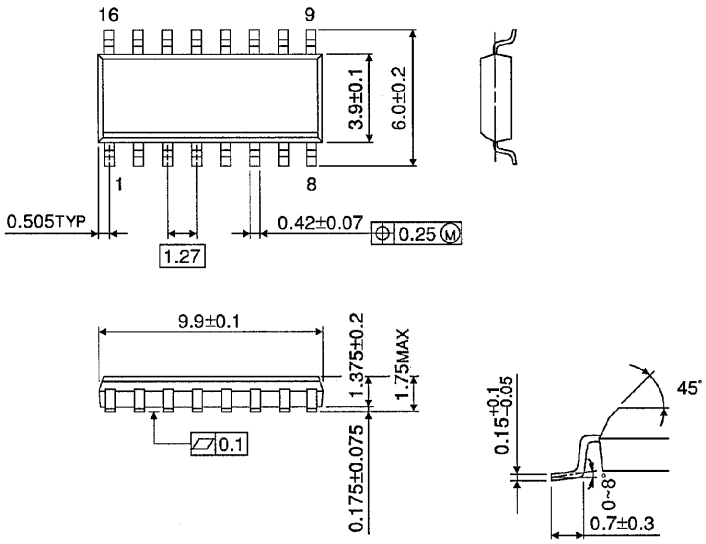
SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27) Unit in mm



Weight : 0.18g (Typ.)

SOP 16PIN (150mil BODY) PACKAGE DIMENSIONS (SOL16-P-150 -1.27) Unit in mm

(Note) This package is not available in Japan.



Weight : 0.13g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.